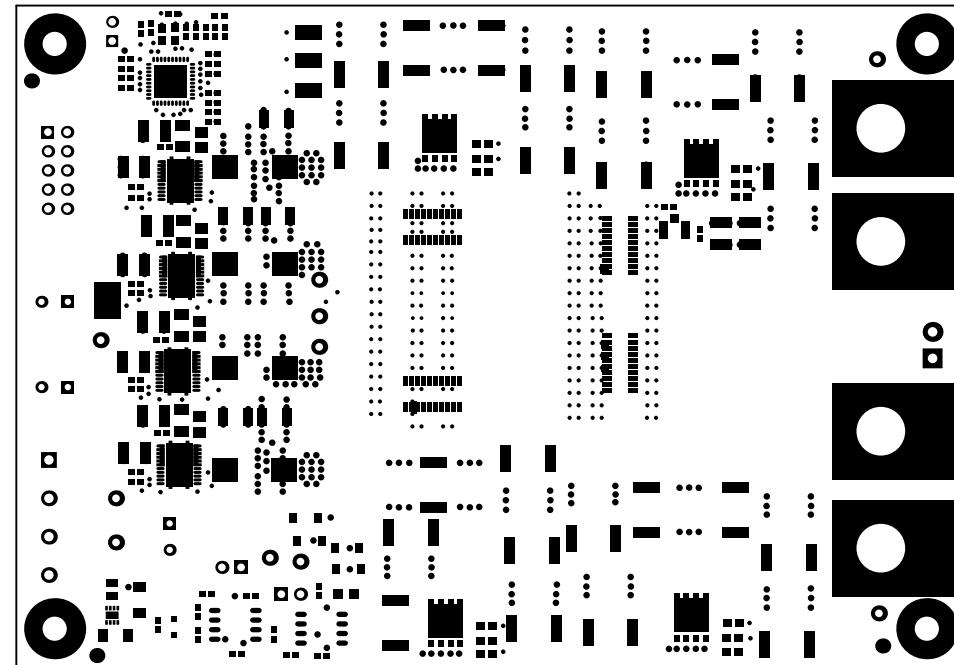
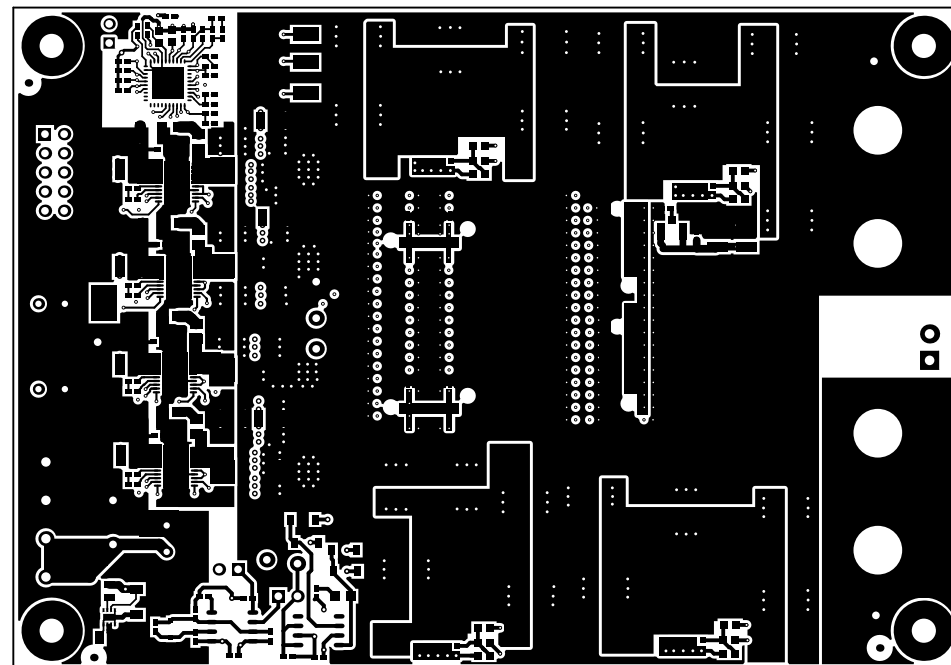


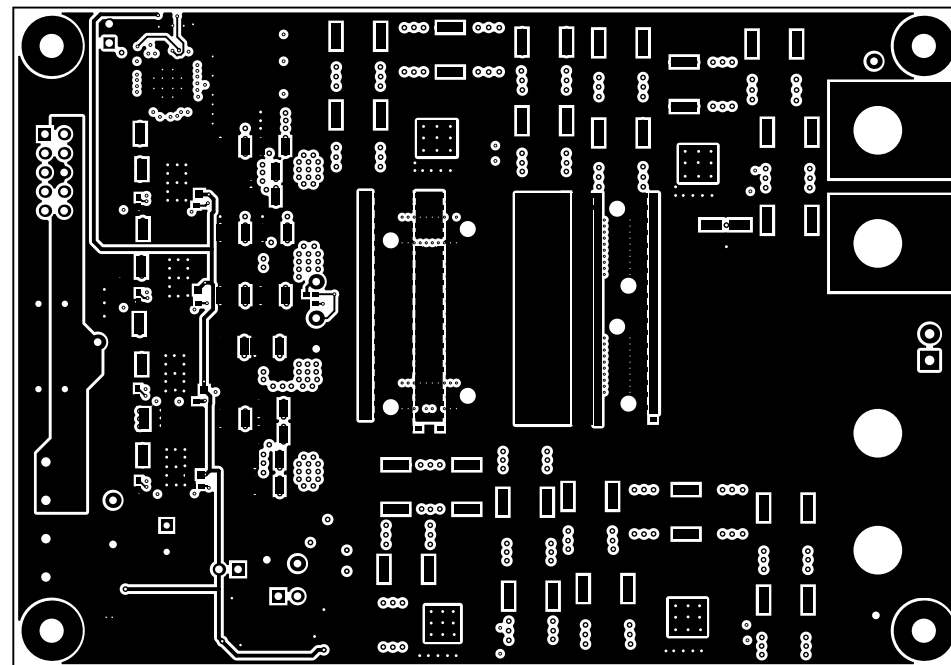
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20176	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: PMP20176		
PLOT NAME = Top Overlay	GENERATED : 6/20/2017 10:51:31 AM	TEXAS INSTRUMENTS	



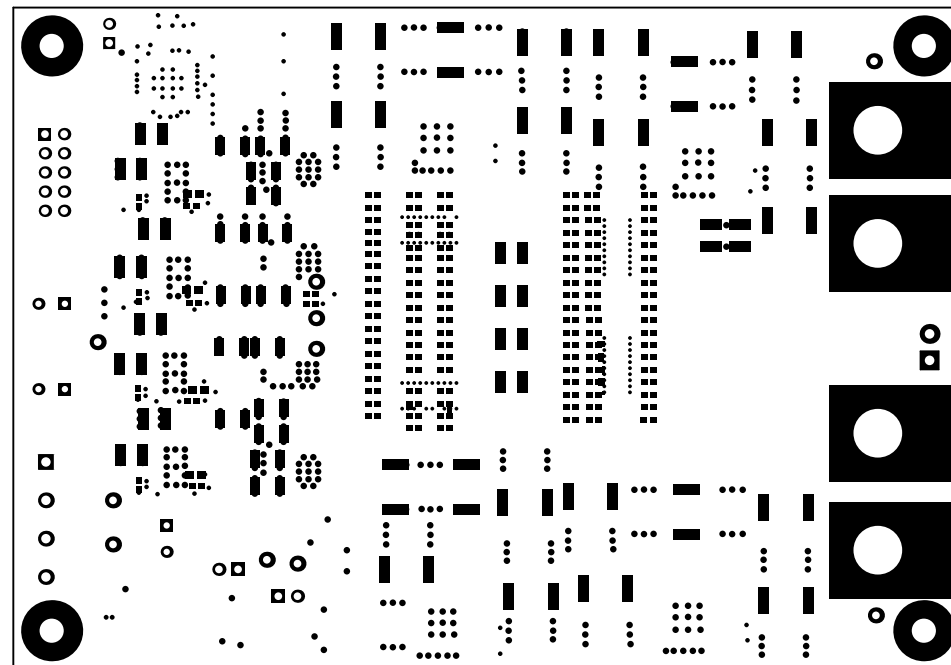
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20176	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: PMP20176		
PLOT NAME = Top Solder Mask	GENERATED : 6/20/2017 10:51:32 AM	TEXAS INSTRUMENTS	



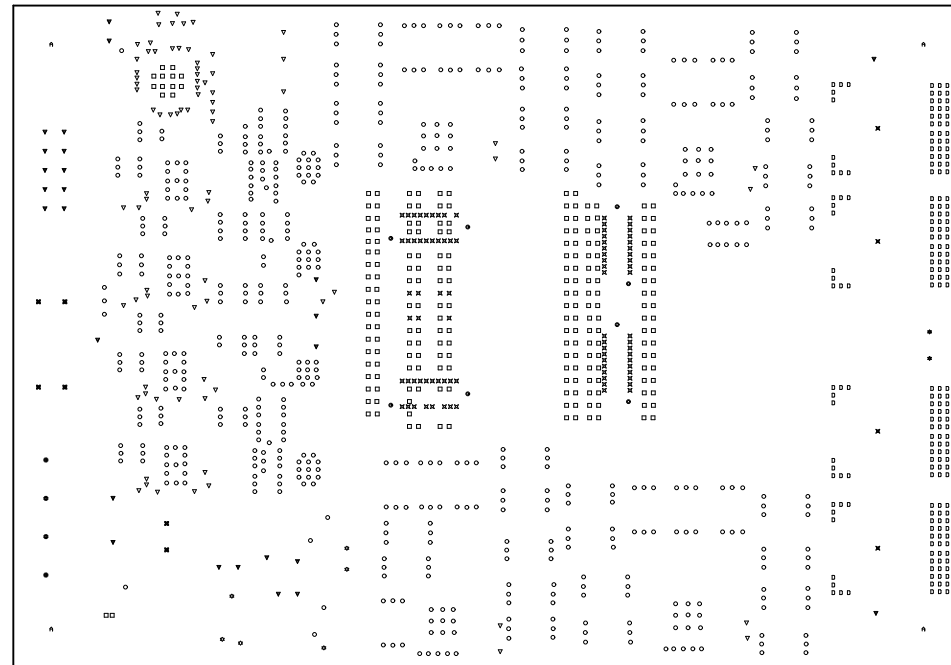
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20176	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: PMP20176		
PLOT NAME = Top Layer	GENERATED : 6/20/2017 10:51:34 AM	TEXAS INSTRUMENTS	



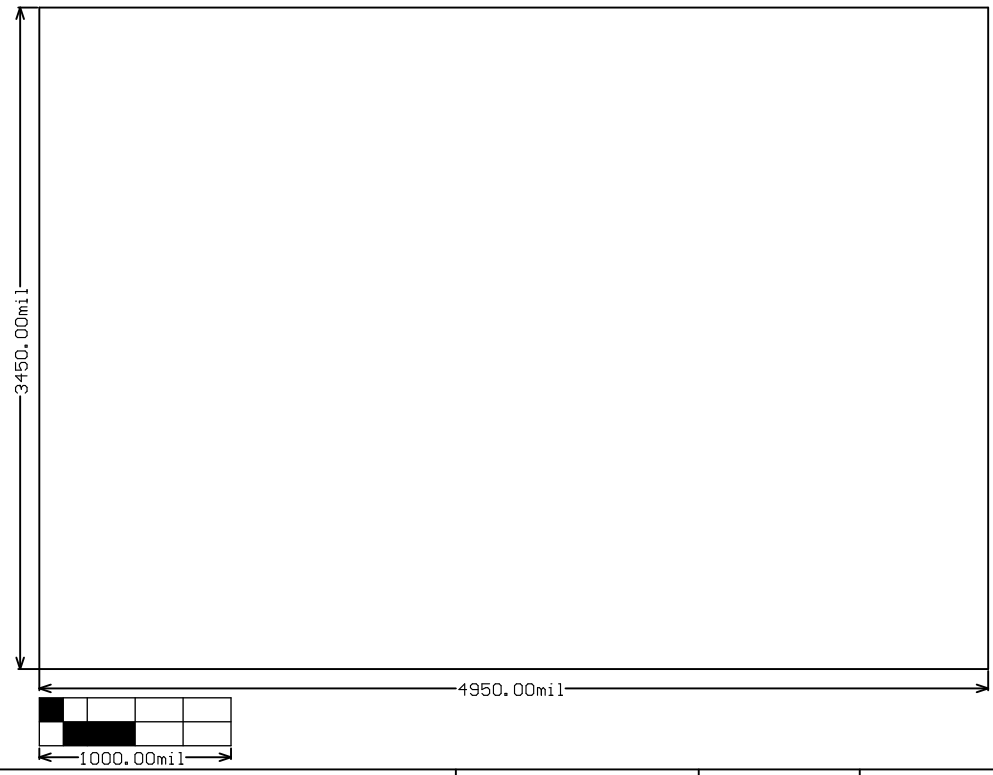
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20176	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: PMP20176		
PLOT NAME = Bottom Layer	GENERATED : 6/20/2017 10:51:35 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20176	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: PMP20176		
PLOT NAME = Bottom Solder Mask	GENERATED : 6/20/2017 10:51:37 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20176	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: PMP20176		
PLOT NAME = Drill Drawing	GENERATED : 6/20/2017 10:51:39 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20176	REV: B	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: PMP20176		
PLOT NAME = Board Dimensions	GENERATED : 6/20/2017 10:51:41 AM	TEXAS INSTRUMENTS	

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